L Number	Hits	Search Text	DB	Time stamp
100	17	(("257/532").CCLS.) and package same capacitor and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/11/13 13:53

L Number	Hits	Search Text	DB	Time stamp
1	56	organic adj binder with polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 08:53
8	6	organic adj binder with polyimide and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 08:59
15	73	(polymer polymeric polyimide) with particle$1 near3 (dielectric insulat$4 non adj conductive) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:27
22	10	Cozar-Ricardo	EPO	2002/11/13 09:26
23	32	substrate with (polymer polymeric polyimide) with (blend$3 fill$3 load$3) near3 (dielectric insulat$4 non adj conductive) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:37
30	248	substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:40
37	4	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/$6 257/$6)) and substrate with (polymer polymeric polyimide) with (plasticizer dispersant) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:43
44	3	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/$6 257/$6)) and substrate with (polymer polymeric polyimide) with (organic adj binder$1) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 09:45
51	3	(substrate with (polymer polymeric polyimide) with (solvent plasticizer dispersant) and (438/$6 257/$6)) and (poly$5) with (organic adj binder$1) and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:08
65	188	kapton adj e	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:11
58	28	dupont with KJ	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 10:10
72	51	kapton adj e and (438/$6 257/$6)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
79	2	("5455390").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
86	0	(("5455390").PN.) and solder with "30"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17

93	1	(("5455390").PN.) and solder	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/13 11:17
-	1210	(257/532).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:16
-	14	(("4945399") or ("5027253") or ("3780352") or ("4982311") or ("5212402")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:20
-	69	(("257/532").CCLS.) and package same capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:13
-	15446	conduct$5 adj trac$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 15:55
-	25	conduct$5 adj trac$4 and (("257/532").CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:06
-	1382	conduct$5 adj trace$1 and capacitor$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:09
-	348	conduct$5 adj trace$1 and capacitor$1 and (438/$ 257/$) not (conduct$5 adj trac$4 and (("257/532").CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/24 16:21
-	97	induct$5 with capac$5 and conduct$5 adj trace$1 and capacitor$1 and (438/$ 257/$) not (conduct$5 adj trac$4 and (("257/532").CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 09:13
-	22	5639989.URPN.	USPAT	2001/10/24 16:42
-	9	("5146047" | "5166772" | "5166864" | "5175613" | "5341274" | "5379185" | "5392197" | "5394304" | "5513078").PN.	USPAT	2001/10/24 16:42
-	1	("4982311").PN.	USPAT	2001/10/25 09:13
-	19	4982311.URPN.	USPAT	2001/10/25 09:13
-	6	("4249196" | "4577214" | "4654694" | "4724472" | "4744008" | "4755910").PN.	USPAT	2001/10/25 09:13
-	81	(("257/532").CCLS.) and (dielectric insulat$3) adj substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:21
-	626	(("257/532").CCLS.) and capacitance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:22
-	251	(("257/532").CCLS.) and capacitance with ("2" "30" "5" "15" "30")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:25

–	2	(("257/532").CCLS.) and capacitance with ("2" "30" "5" "15" "30") near nf$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:18
–	86	capacitance with ("2" "30" "5" "15" "30") near nf$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:34
–	0	capacitance with ("2" "30" "5" "15" "30") near "nf/sq.cm"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:35
–	5	capacitance with ("2" "30" "5" "15" "30") near "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:05
–	5	(("257/532").CCLS.) and "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:43
–	0	(("257/532").CCLS.) and (ground adj2 plane and power adj2 plane) with um	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:56
–	0	(("257/532").CCLS.) and (ground adj2 plane and power adj2 plane) with "um"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:59
–	14	(("257/532").CCLS.) and "um"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 10:59
–	0	"um" same "nf/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:18
–	4	(("257/532").CCLS.) and polyimide near3 substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
–	0	(("257/532").CCLS.) and solder adj plug	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
–	190	solder adj plug	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:46
–	1	solder adj plug with interconnect	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 11:47
–	3	solder adj plug with interconnect$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:01

–	18	(non adj conduct$4 nonconduct$4 insulat$4 dielectric) near2 polymer same (BST PZT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:11
–	10	(non adj conduct$4 nonconduct$4 insulat$4 dielectric) near2 polymer with (BST PZT)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:04
–	8	((non adj conduct$4 nonconduct$4 insulat$4 dielectric) near2 polymer same (BST PZT)) not ((non adj conduct$4 nonconduct$4 insulat$4 dielectric) near2 polymer with (BST PZT))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2001/10/25 12:11
–	6	(("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.	USPAT	2002/02/04 14:31
–	0	6184567.URPN.	USPAT	2002/02/04 14:29
–	5	("4494169" | "5099388" | "5144526" | "5590017" | "5767564").PN.	USPAT	2002/02/04 14:29
–	1	6068782.URPN.	USPAT	2002/02/04 14:30
–	18	("4065742" | "4409608" | "4437140" | "4460938" | "4490429" | "4650544" | "4878155" | "4908258" | "5010641" | "5027253" | "5065284" | "5079069" | "5155655" | "5161086" | "5162977" | "5261153" | "5347258" | "5656834").PN.	USPAT	2002/02/04 14:30
–	2	5883428.URPN.	USPAT	2002/02/04 14:30
–	7	("4835344" | "5370907" | "5371403" | "5394008" | "5399902" | "5402318" | "5468694").PN.	USPAT	2002/02/04 14:30
–	22	5639989.URPN.	USPAT	2002/02/04 14:30
–	9	("5146047" | "5166772" | "5166864" | "5175613" | "5341274" | "5379185" | "5392197" | "5394304" | "5513078").PN.	USPAT	2002/02/04 14:30
–	12	5633785.URPN.	USPAT	2002/02/04 14:30
–	13	("3566203" | "4744008" | "4945399" | "4949163" | "4984065" | "4994895" | "5049979" | "5055966" | "5119172" | "5148265" | "5148266" | "5281846" | "5311057").PN.	USPAT	2002/02/04 14:30
–	20	4982311.URPN.	USPAT	2002/02/04 14:30
–	6	("4249196" | "4577214" | "4654694" | "4724472" | "4744008" | "4755910").PN.	USPAT	2002/02/04 14:30
–	113	(6184567.URPN. (("4494169" | "5099388" | "5144526" | "5590017" | "5767564").PN.) 6068782.URPN. (("4065742" | "4409608" | "4437140" | "4460938" | "4490429" | "4650544" | "4878155" | "4908258" | "5010641" | "5027253" | "5065284" | "5079069" | "5155655" | "5161086" | "5162977" | "5261153" | "5347258" | "5656834").PN.) 5883428.URPN. (("4835344" | "5370907" | "5371403" | "5394008" | "5399902" | "5402318" | "5468694").PN.) 5639989.URPN. (("5146047" | "5166772" | "5166864" | "5175613" | "5341274" | "5379185" | "5392197" | "5394304" | "5513078").PN.) 5633785.URPN. (("3566203" | "4744008" | "4945399" | "4949163" | "4984065" | "4994895" | "5049979" | "5055966" | "5119172" | "5148265" | "5148266" | "5281846" | "5311057").PN.) 4982311.URPN. (("4249196" | "4577214" | "4654694" | "4724472" | "4744008" | "4755910").PN.)) not (((("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.))	USPAT	2002/02/04 16:24
–	5	5831825.URPN.	USPAT	2002/02/04 14:58

–	11	("4731701" | "4982311" | "5050040" | "5319237" | "5347091" | "5471366" | "5475264" | "5506755" | "5583377" | "5600541" | "5608261").PN.	USPAT	2002/02/04 14:58
–	8	("3880493" | "4249196" | "4654694" | "4739448" | "4982311" | "5095402" | "5212402" | "5272590").PN.	USPAT	2002/02/04 14:58
–	6	5475565.URPN.	USPAT	2002/02/04 14:58
–	14	4949163.URPN.	USPAT	2002/02/04 14:58
–	1	"4751482".PN.	USPAT	2002/02/04 14:58
–	13	4755910.URPN.	USPAT	2002/02/04 14:59
–	15	("4288841" | "4320438" | "4408256" | "4413170" | "4518818" | "4546028" | "4553020" | "4559579" | "4563725" | "4578697" | "4614194" | "4628407" | "4639826" | "4651192" | "4654694").PN.	USPAT	2002/02/04 14:59
–	62	(5831825.URPN. (("4731701" | "4982311" | "5050040" | "5319237" | "5347091" | "5471366" | "5475264" | "5506755" | "5583377" | "5600541" | "5608261").PN.) (("3880493" | "4249196" | "4654694" | "4739448" | "4982311" | "5095402" | "5212402" | "5272590").PN.) 5475565.URPN. 4949163.URPN. "4751482".PN. 4755910.URPN. (("4288841" | "4320438" | "4408256" | "4413170" | "4518818" | "4546028" | "4553020" | "4559579" | "4563725" | "4578697" | "4614194" | "4628407" | "4639826" | "4651192" | "4654694").PN.)) not (6184567.URPN. (("4494169" | "5099388" | "5144526" | "5590017" | "5767564").PN.) 6068782.URPN. (("4065742" | "4409608" | "4437140" | "4460938" | "4490429" | "4650544" | "4878155" | "4908258" | "5010641" | "5027253" | "5065284" | "5079069" | "5155655" | "5161086" | "5162977" | "5261153" | "5347258" | "5656834").PN.) 5883428.URPN. (("4835344" | "5370907" | "5371403" | "5394008" | "5399902" | "5402318" | "5468694").PN.) 5639989.URPN. (("5146047" | "5166772" | "5166864" | "5175613" | "5341274" | "5379185" | "5392197" | "5394304" | "5513078").PN.) 5633785.URPN. (("3566203" | "4744008" | "4945399" | "4949163" | "4984065" | "4994895" | "5049979" | "5055966" | "5119172" | "5148265" | "5148266" | "5281846" | "5311057").PN.) 4982311.URPN. (("4249196" | "4577214" | "4654694" | "4724472" | "4744008" | "4755910").PN.) ((("6184567") or ("5633785") or ("5883428") or ("6068782") or ("5639989") or ("4982311")).PN.))	USPAT	2002/02/04 15:00
–	84	(("257/532").CCLS.) and decoup$5 with capacit$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:25
–	15584	"84" and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:16
–	7	((("257/532").CCLS.) and decoup$5 with capacit$5) and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:43

-	514	embed$4 near capacit$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:42
-	27	(embed$4 near capacit$5) and @pd>=20011025	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 15:44
-	1	nanofarrad$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:25
-	682	nanofarad$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:40
-	58	nanofarad$5 and decoup$5 with capacit$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	112	polymer with ceramic with dielectric adj constant	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:40
-	125	polymer with (metal adj oxide$1 ceramic$1) with dielectric adj constant	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	59	"nF/cm.sup.2"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:45
-	8	"nF/cm.sup.2" and decoup$5 with capacit$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/02/04 16:46
-	0	("substrate with polymer with particle$1").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:10
-	3528	substrate with polymer with particle$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:15
-	2	substrate with polymer with high adj dielectric near2 particle$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:20
-	3	substrate with (polyimide polymeric polymer) with high adj dielectric near2 particle$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:23
-	1	(substrate with (polyimide polymeric polymer) with high adj dielectric near2 particle$1) not (substrate with polymer with high adj dielectric near2 particle$1)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/11/12 17:30